

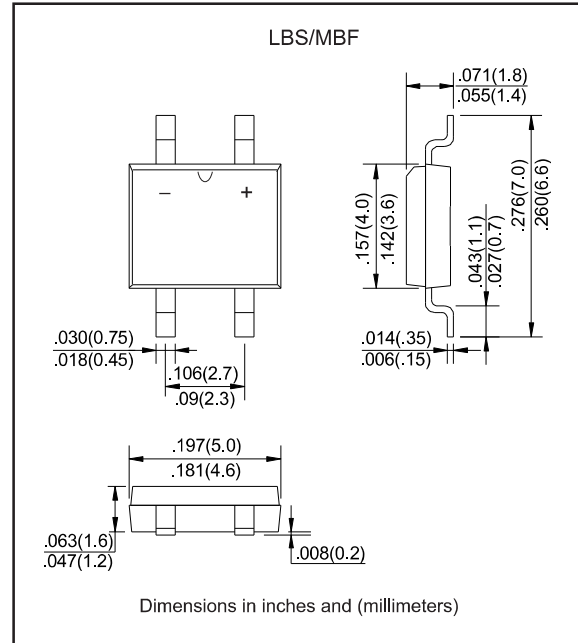
Features

- Surge overload ratings to 30 amperes peak.
- Save space on printed circuit board.
- Ideal for automated replacement.
- Reliable low cost construction utilizing molded plastic technology results in inexpensive product.
- Glass passivated chip junctions.
- Lead-free parts meet RoHS requirements.
- UL recognized file # E321971
- Suffix "-H" indicates Halogen free part, ex. MB05F-H.

Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, LBS/MBF
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : marked on body
- Mounting Position : Any

Package outline



Maximum ratings and Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	On glass-epoxy P.C.B.	I_O			0.5	A
	On aluminum substrate				0.8	
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I_{FSM}			30	A
Reverse current	$V_R = V_{RRM}$ $T_J = 25^{\circ}\text{C}$	I_R			5.0	uA
	$V_R = V_{RRM}$ $T_J = 125^{\circ}\text{C}$				200	
Thermal resistance	Junction to ambient	$R_{\theta JA}$		60		$^{\circ}\text{C}/\text{W}$
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C_J		13		pF
Storage temperature		T_{STG}	-55		+150	$^{\circ}\text{C}$

SYMBOLS	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature T_J , ($^{\circ}\text{C}$)
MB05F	50	35	50	1.00	-55 to +150
MB1F	100	70	100		
MB2F	200	140	200		
MB4F	400	280	400		
MB6F	600	420	600		
MB8F	800	560	800		
MB10F	1000	700	1000		

*1 Repetitive peak reverse voltage

*2 RMS voltage

*3 Continuous reverse voltage

*4 Maximum forward voltage

per element at 0.8A peak

Rating and characteristic curves (MB05F THRU MB10F)

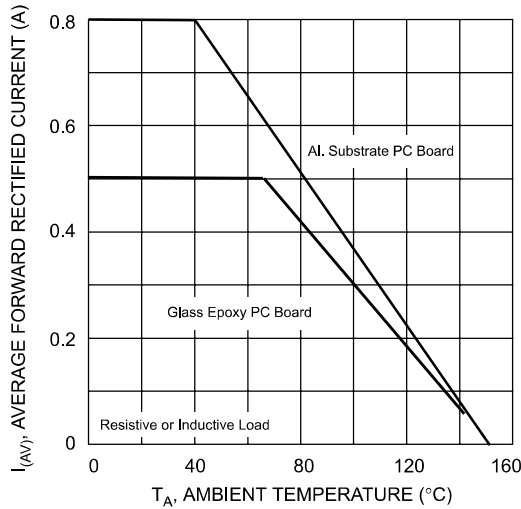


Fig. 1 Output Current Derating Curve

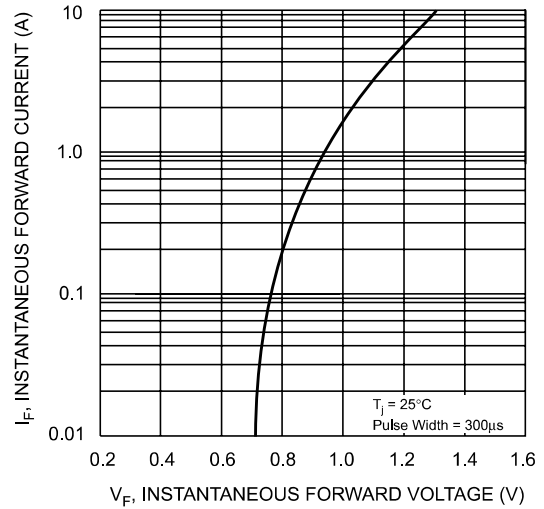


Fig. 2 Typical Forward Characteristics (per leg)

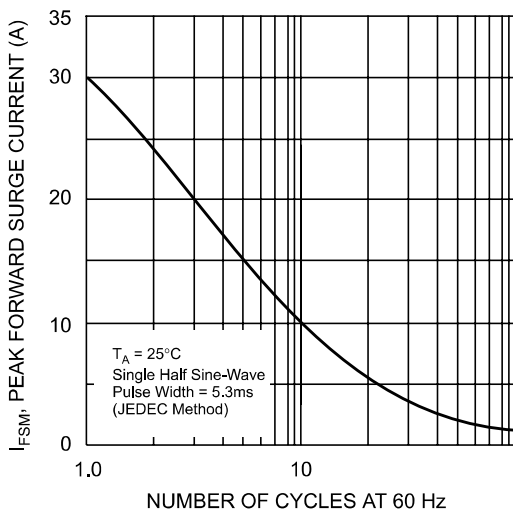


Fig. 3 Maximum Peak Forward Surge Current (per leg)

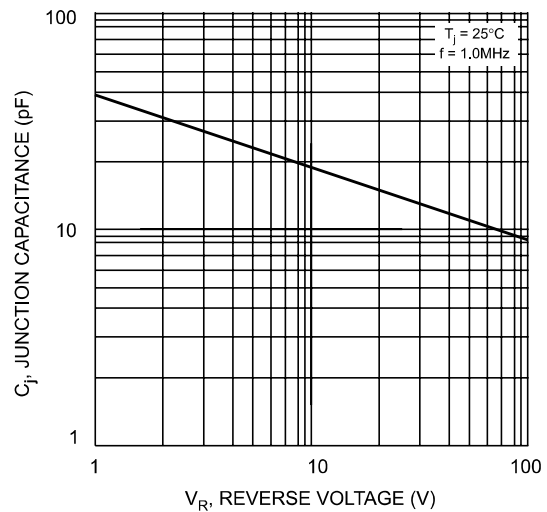


Fig. 4 Typical Junction Capacitance

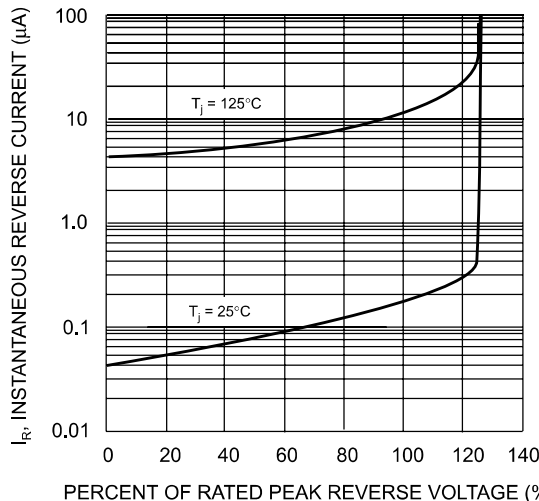
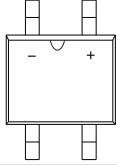
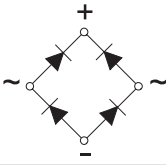

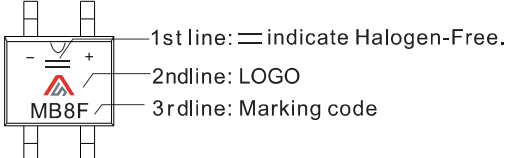


Fig. 5 Typical Reverse Characteristics (per element)

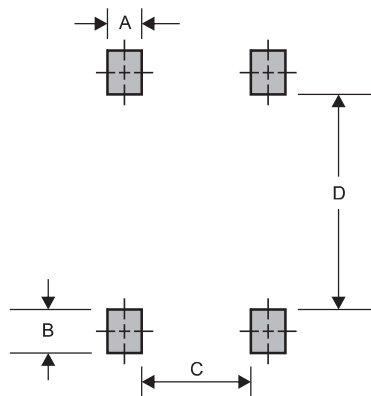
Pinning information

Simplified outline	Symbol
	

Marking

Type number	Marking code	Example	
MB05F	MB05F	1. For Halogen Device 	2. For Halogen-free Device 
MB1F	MB1F		
MB2F	MB2F		
MB4F	MB4F		
MB6F	MB6F		
MB8F	MB8F		
MB10F	MB10F		

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C	D
LBS/MBF	0.023 (0.58)	0.030 (0.76)	0.070 (1.78)	0.226 (5.75)

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